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Applicant(s): Wayne G. Renken

Title: Process Condition Sensing Wafer and Data Analysis System

Application No.: 10/056,906 Filing Date: January 24, 2002

Examiner: Charles D. Garber Group Art Unit: 2856

Docket No.: SENS.005US0 Conf. No.: 2359

Mail Stop Amendment  
Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

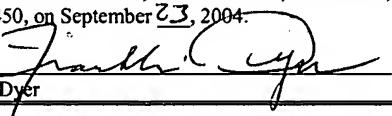
Transmitted herewith are the following documents in the above-identified application:

(1) Amendment (12 pages); and

(2) Return Postcard.

Certificate of Mailing Under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope address to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 23, 2004.

  
Franklin Dyer

Respectfully submitted,



Peter A. Gallagher  
Reg. No.47,584

9/23/04  
Date



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Wayne G. Renken  
Title: Process Condition Sensing Wafer And Data Analysis System  
Application No.: 10/685,550 Filing Date: October 14, 2003  
Examiner: Charles D. Garber Group Art Unit: 2856  
Docket No.: SENS.005US1 Conf. No.: 4924

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Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Sir:

This is in response to the non-final Office Action dated June 29, 2004, setting a period for response expiring on September 29, 2004.

Claim Amendments are reflected in the listing of claims, which begins on page 2 of this paper.

Drawing Amendments are not being made.

Specification Amendments are not being made.

Remarks begin on page 7 of this paper.